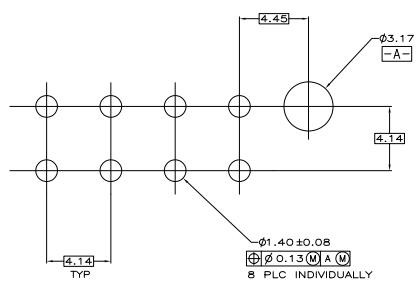
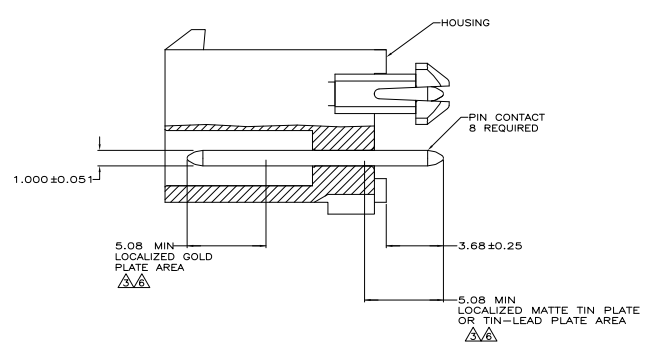
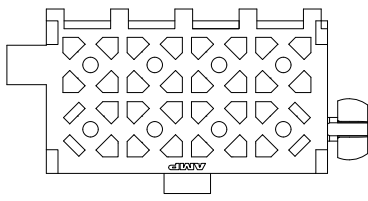
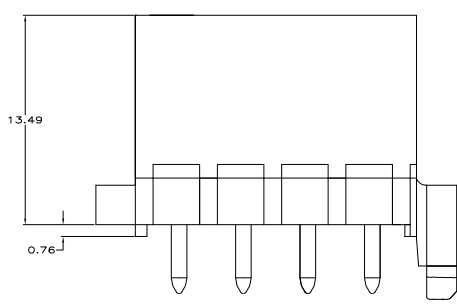
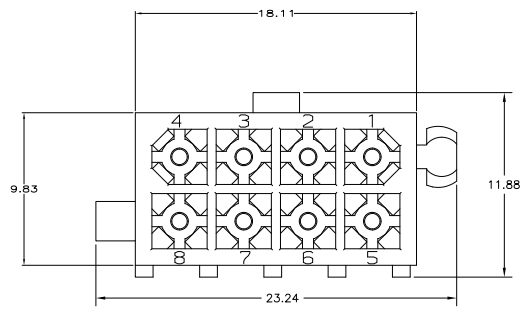


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REV	DATE	DESCRIPTION	BY	CHK
01				
02		REVISED PER EDD-11-004917	11MMR11	RK HMR



RECOMMENDED MOUNTING HOLE PATTERN FOR 1.57 THICK P.C. BOARD

- PINS TO COMPLY WITH AMP SOLDERABILITY SPEC. 109-11-3.
- 0.00381 MIN MATTE TIN LEAD PLATE OVER 0.00127 MIN NICKEL.
- 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN LEAD IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.
- 0.00381 MIN MATTE TIN PLATE OVER 0.00127 MIN NICKEL.
- 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.

MATERIAL	FINISH	MATERIAL	COLOR	PART NO.
BRASS, TIN	△	HIGH TEMP NYLON, UL94V-2	BLACK	6-794065-0
BRASS, TIN	△	HIGH TEMP NYLON, UL94V-0	BLACK	5-794065-0
BRASS, GOLD	△	NYLON, UL94V-0	WHITE	1-794065-1
BRASS, TIN	△	NYLON, UL94V-0	WHITE	1-794065-0
BRASS, GOLD	△	NYLON, UL94V-0	WHITE	794065-2
BRASS, TIN-LEAD	△	NYLON, UL94V-0	WHITE	794065-1

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TE Connectivity

HEADER ASSEMBLY, 8 CKT, DOUBLE ROW VERTICAL, MINI UNIVERSAL, MATE-IN-LOCK(TM)

DATE: 01/00779 ©=794065

CUSTOMER DRAWING